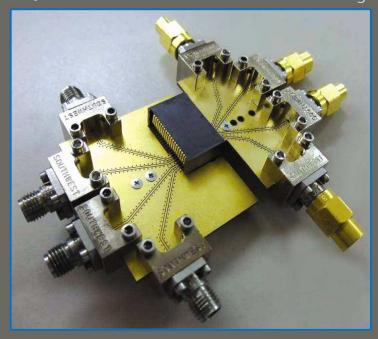
YAMAICHI ELECTRONICS



INCREASE YOUR BANDWIDTH SPEED WITH EASE

eQSFP+ with module & host boards for testing



The eQSFP+ offers:

- RoHS compliancy
- High-bandwidth speeds of 25G & 28G/lane per InfiniBand EDR & OIF-28G (100GbE) requirements
- Drop-in replacement on existing QSFP+ board layouts
- Backward compatibility with existing OSFP+ modules
- 3 different scalable mating options: 0.6mm module pads for compatibility, 0.5mm module pads for advanced performance & plug board mating for even superior performance
- High-temperature thermoplastic glass-filled housing (UL 94 V-0)

eXFP+ for 25G/28G extended performance to 25G/28G

Yamaichi's Quad Small Form-factor Pluggable (eQSFP+) solution is designed as a drop-in replacement for existing QSFP+ connector board layouts. It has the same outline dimensions as existing QSFP+ connectors and is compatible with existing cage designs.

Not only is it a convenient solution from a physical standpoint, but the eQSFP+ facilitates high-bandwidth speeds of 25G & 28G per InfiniBand EDR & OIF CEI-28G (100GbE) standards.

